## **DSC2G03**

### Silicon NPN epitaxial planar type

For high-frequency amplification

#### ■ Features

- High transition frequency f<sub>T</sub>
- Halogen-free / RoHS compliant (EU RoHS / UL-94 V-0 / MSL: Level 1 compliant)

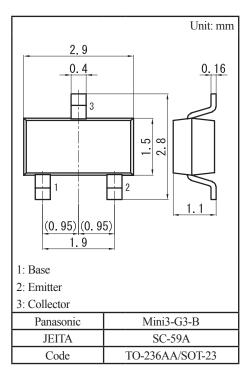
#### ■ Marking Symbol: C6

#### ■ Packaging

DSC2G03×0L Embossed type (Thermo-compression sealing): 3 000 pcs / reel (standard)

#### ■ Absolute Maximum Ratings $T_a = 25$ °C

Parameter	Symbol	Rating	Unit
Collector-base voltage (Emitter open)	V <sub>CBO</sub>	30	V
Collector-emitter voltage (Base open)	V <sub>CEO</sub>	20	V
Emitter-base voltage (Collector open)	V <sub>EBO</sub>	3	V
Collector current	$I_{C}$	50	mA
Collector power dissipation	P <sub>C</sub>	200	mW
Junction temperature	T <sub>j</sub>	150	°C
Operating ambient temperature	T <sub>opr</sub>	-40 to +85	°C
Storage temperature	T <sub>stg</sub>	-55 to +150	°C



#### ■ Electrical Characteristics $T_a = 25$ °C±3°C

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Collector-base voltage (Emitter open)	$V_{CBO}$	$I_C = 100 \mu A, I_E = 0$	30			V
Emitter-base voltage (Collector open)	$V_{EBO}$	$I_E = 10 \mu A, I_C = 0$	3			V
Base-emitter voltage	V <sub>BE</sub>	$V_{CE} = 10 \text{ V}, I_{C} = 2 \text{ mA}$		740		mV
Forward current transfer ratio	h <sub>FE</sub>	$V_{CE} = 10 \text{ V}, I_{C} = 2 \text{ mA}$	25		250	_
Transition frequency *1,2	$f_T$	$V_{CE} = 10 \text{ V}, I_{C} = 15 \text{ mA}$	800		1600	MHz
Reverse transfer capacitance (Common emitter)	C <sub>re</sub>	$V_{CE} = 10 \text{ V}, I_{C} = 1 \text{ mA}, f = 10.7 \text{ MHz}$		0.9		pF
Reverse transfer capacitance (Common base)	C <sub>rb</sub>	$V_{CB} = 6 \text{ V}, I_{C} = 0 , f = 1 \text{ MHz}$		0.7		pF
Power gain	PG	$V_{CE} = 10 \text{ V}, I_{C} = 1 \text{ mA}, f = 200 \text{ MHz}$		20		dB

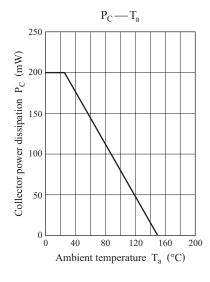
Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

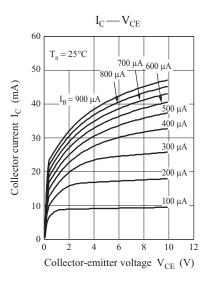
#### 2. \*1: Pulse measurement

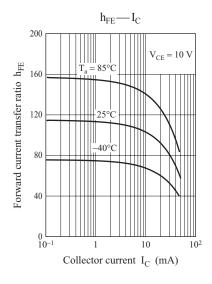
#### \*2: Rank classification

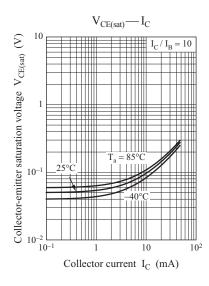
Code	Т	S	0	
Rank	Т	S	No-rank	
$f_{T}$	800 to 1400	1000 to 1600	800 to 1 600	
Marking Symbol	С6Т	C6S	C6	

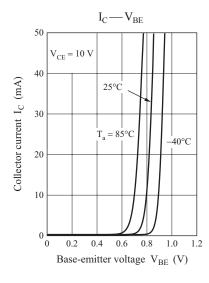
Product of no-rank is not classified and have no marking symbol for rank.

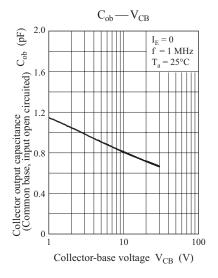


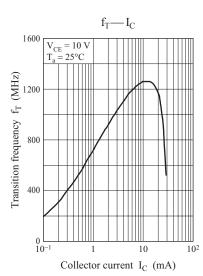












Ver. BED 2

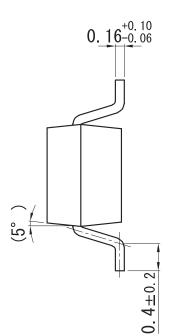
Unit: mm

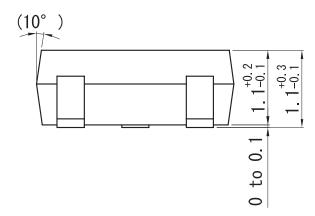
Mini3-G3-B

(0.95)

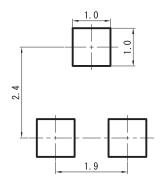
(0.95)

 $1.9 \pm 0.1$ 





#### ■ Land Pattern (Reference) (Unit: mm)



(0.65)

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